

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Dai KAWASAKI</td><td>03/08/2007</td></tr><tr><td>Nagatoshi FUJIEDA</td><td>03/08/2007</td></tr><tr><td>Nori SASAKI</td><td>03/08/2007</td></tr><tr><td>Noriyuki YAMAZAKI</td><td>03/08/2007</td></tr></tbody></table>		Name	Execution Date	Dai KAWASAKI	03/08/2007	Nagatoshi FUJIEDA	03/08/2007	Nori SASAKI	03/08/2007	Noriyuki YAMAZAKI	03/08/2007
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<table border="1"><tr><td>Name:</td><td>Hitachi Chemical DuPont MicroSystems, Ltd.</td></tr><tr><td>Street Address:</td><td>4-1, Koishikawa 1-chome, Bunkyo-ku</td></tr><tr><td>City:</td><td>Tokyo</td></tr><tr><td>State/Country:</td><td>JAPAN</td></tr><tr><td>Postal Code:</td><td>112-0002</td></tr></table>		Name:	Hitachi Chemical DuPont MicroSystems, Ltd.	Street Address:	4-1, Koishikawa 1-chome, Bunkyo-ku	City:	Tokyo	State/Country:	JAPAN	Postal Code:	112-0002
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PROPERTY NUMBERS Total: 1											
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CORRESPONDENCE DATA											
Fax Number: (703)979-7429 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
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ATTORNEY DOCKET NUMBER:	SAKAI0002										
NAME OF SUBMITTER:	Joerg-Uwe Szipl										

OP \$40.00 11688610

500242695

PATENT
REEL: 019037 FRAME: 0480

ASSIGNMENT

The undersigned (hereinafter collectively referred to as "ASSIGNOR"), in consideration of the sum of Ten Dollars (\$10.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, hereby sells, assigns and transfers to

Hitachi Chemical DuPont MicroSystems, Ltd.

(hereinafter referred to as "ASSIGNEE"), of

4-1, Koishikawa 1-chome, Bunkyo-ku 112-0002, Japan

the entire right, title and interest for the United States of America as defined in 35 U.S.C. §100, in the invention (hereinafter "INVENTION") entitled:

PHOTOSENSITIVE RESIN COMPOSITION, PATTERN FORMING METHOD AND ELECTRONIC PARTS USING THE PHOTOSENSITIVE RESIN COMPOSITION

for which Assignor has executed an application for United States Patent

☒ on this date (check if assignment and application are executed on same date)

☐ filed on [_____] (check if Assignment is executed after application)
Month/Day/Year

as United States Patent Application No. _____
(Insert if known)

and all applications on the INVENTION, including any and all divisions, continuations, substitutes and reissues thereof, and all resulting patents on the INVENTION;


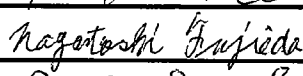

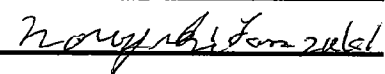
ASSIGNOR hereby agrees to testify and to execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE'S full protection of and title in and to the INVENTION hereby transferred; and

ASSIGNOR hereby authorizes Joerg-Uwe Szipl and Griffin & Szipl, P.C. to insert in this ASSIGNMENT any further information necessary or desirable for recordation.

Full Name of the Inventor(s)
(Please type)

Signature

Date Signed

(1) Dai KAWASAKI		March 8, 2007
(2) Nagatoshi FUJIEDA		March 8, 2007
(3) Nori SASAKI		March 8, 2007
(4) Noriyuki YAMAZAKI		March 8, 2007
(5)		
(6)		

☐ Check if additional pages are attached.

* For use with non-U.S. inventors.

Revised July 2005

PATENT

RECORDED: 03/20/2007

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